

## TO-220-2L Plastic-Encapsulate Diode

**CSD20H120** Silicon Carbide Schottky Diode

### MAIN CHARACTERISTICS

$I_o$	<b>20A</b> ( $T_c \leq 117^\circ\text{C}$ )
$V_{RRM}$	<b>1200V</b>
$T_j$	<b>175°C</b>
$V_{F(typ)}$	<b>1.45V</b> (@ $T_j=25^\circ\text{C}$ ) <b>2.35V</b> (@ $T_j=175^\circ\text{C}$ )

### FEATURES

- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- Temperature-independent performance
- High-speed switching
- Low switching loss
- Low Leakage Current

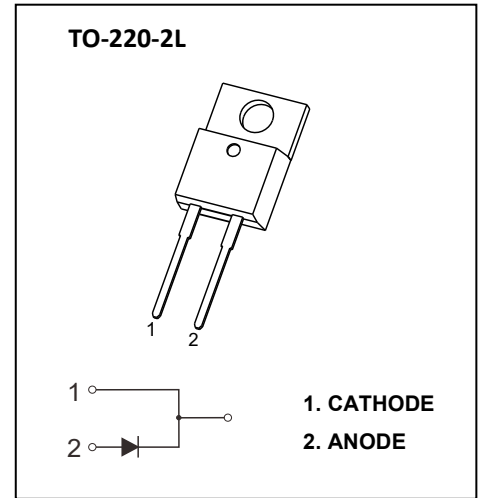
### Application

- Industrial Power Supplies
- Power factor correction
- Motor drive traction
- EV charging station
- Solar Inverters

### MARKING



CSD20H120 = Device code  
 Solid dot = Green molding compound device  
 if none, the normal device  
 XXXX = Code



### MAXIMUM RATINGS ( $T_j=25^\circ\text{C}$ unless otherwise noted)

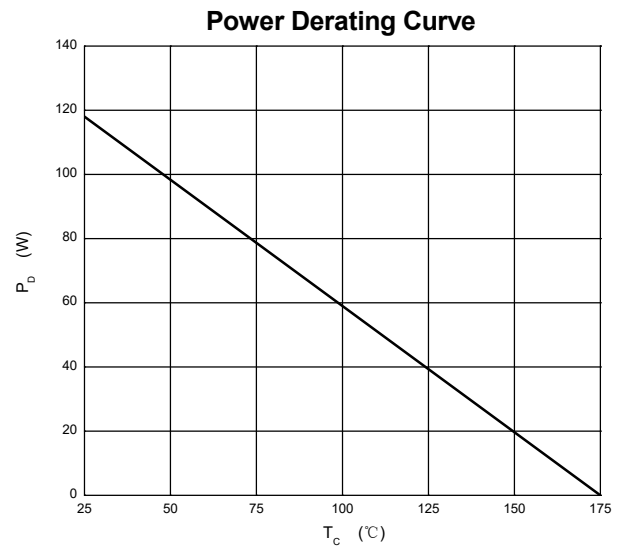
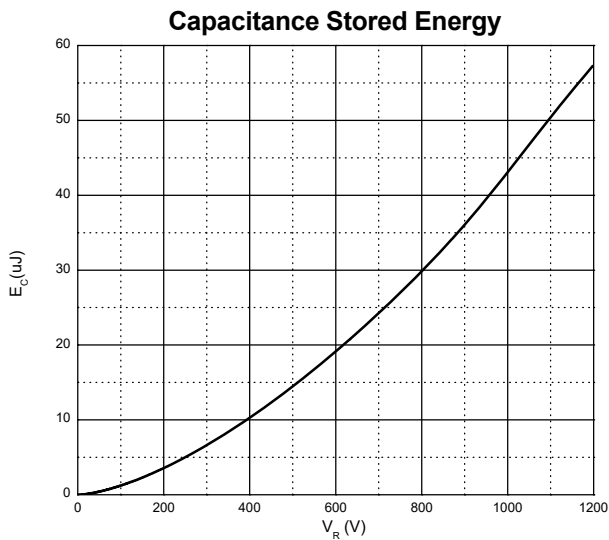
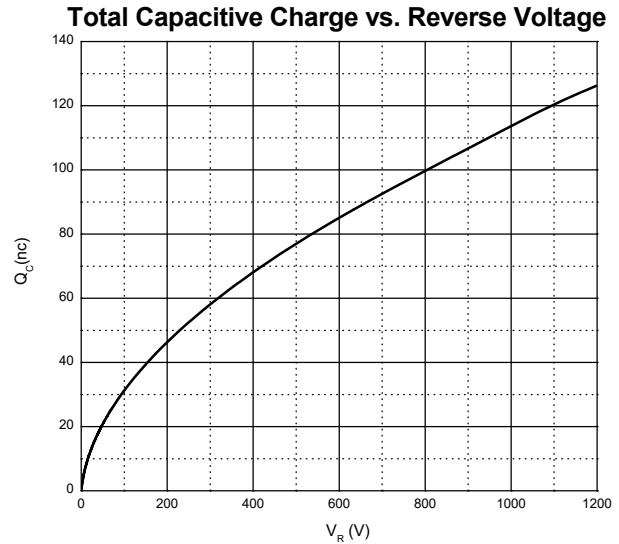
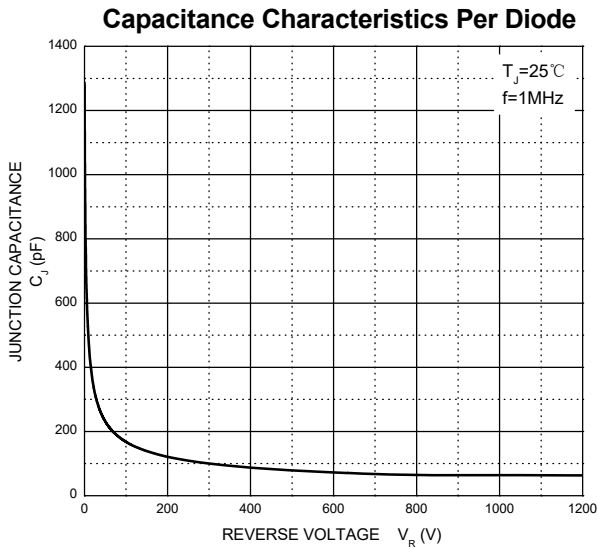
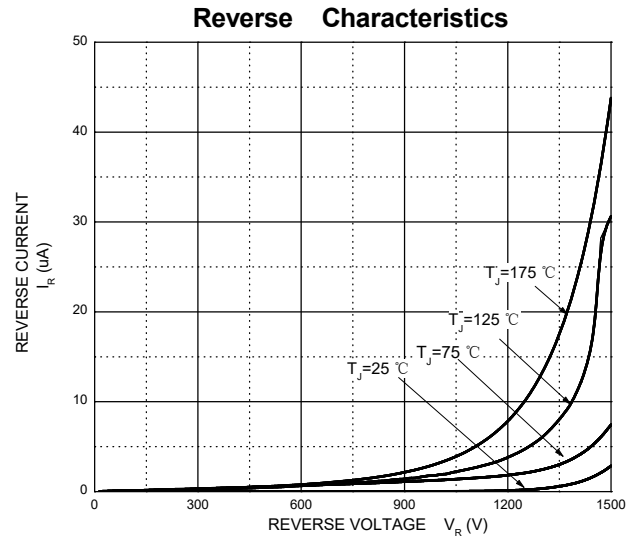
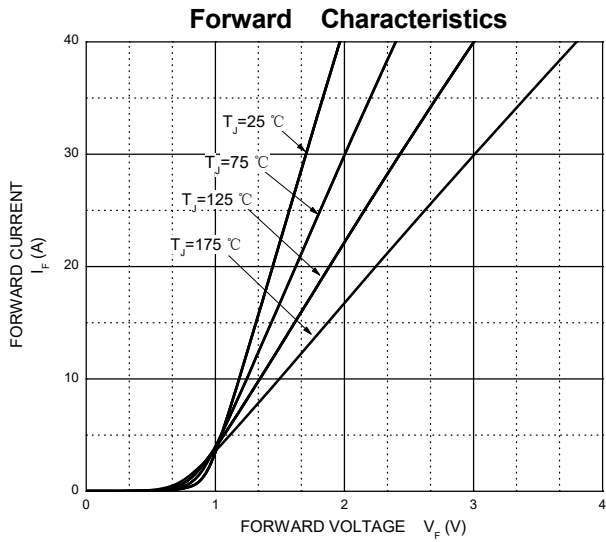
Symbol	Parameter	Value	Unit	
$V_{RRM}$	Peak repetitive reverse voltage	1200	V	
$V_{RWM}$	Working peak reverse voltage			
$V_R$	DC blocking voltage			
$I_{F(AV)}$	Average Forward Current	$T_c \leq 25^\circ\text{C}$	35	A
		$T_c \leq 100^\circ\text{C}$	23	A
		$T_c \leq 117^\circ\text{C}$	20	A
$I_{FSM}$	Non-Repetitive peak forward surge current (10ms half sine wave)	188	A	
$\int i^2 dt$	$\int i^2 dt$ value ( $t_p=10\text{ms}$ )	176	A <sup>2</sup> s	
$P_D$	Power dissipation	118	W	
$R_{\theta JC}$	Thermal Resistance From Junction to Case	1.27	°C/W	
$T_j$	Junction temperature	-55~175	°C	
$T_{stg}$	Storage temperature	-55~175	°C	

## Typical Characteristics

### ELECTRICAL CHARACTERISTICS( $T_j=25^{\circ}\text{C}$ unless otherwise specified)

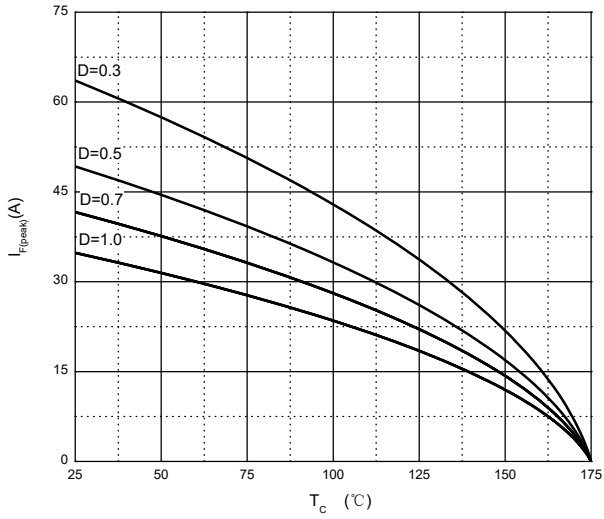
Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Reverse voltage	$V_{(BR)}$	$I_R=100\mu\text{A}$	1200			V
Reverse current	$I_R$	$V_R=1200\text{V}$	$T_j=25^{\circ}\text{C}$	5	50	$\mu\text{A}$
			$T_j=175^{\circ}\text{C}$	20	200	$\mu\text{A}$
Forward voltage	$V_F$	$I_F=20\text{A}$	$T_j=25^{\circ}\text{C}$	1.45	1.8	V
			$T_j=175^{\circ}\text{C}$	2.35	3.0	V
Total capacitance	C	$V_R=0\text{V}, f=1\text{MHz}$		1286		pF
		$V_R=400\text{V}, f=1\text{MHz}$		85		pF
		$V_R=800\text{V}, f=1\text{MHz}$		64		pF
Total capacitive charge	$Q_C$	$V_R=800\text{V}$ $Q_C=\int_0^{V_R} C(V)dV$		101		nC
Capacitance Stored Energy	$E_C$	$V_R=800\text{V}$ $E_C=\int_0^{V_R} C(V) \cdot VdV$		31		$\mu\text{J}$

# Typical Characteristics

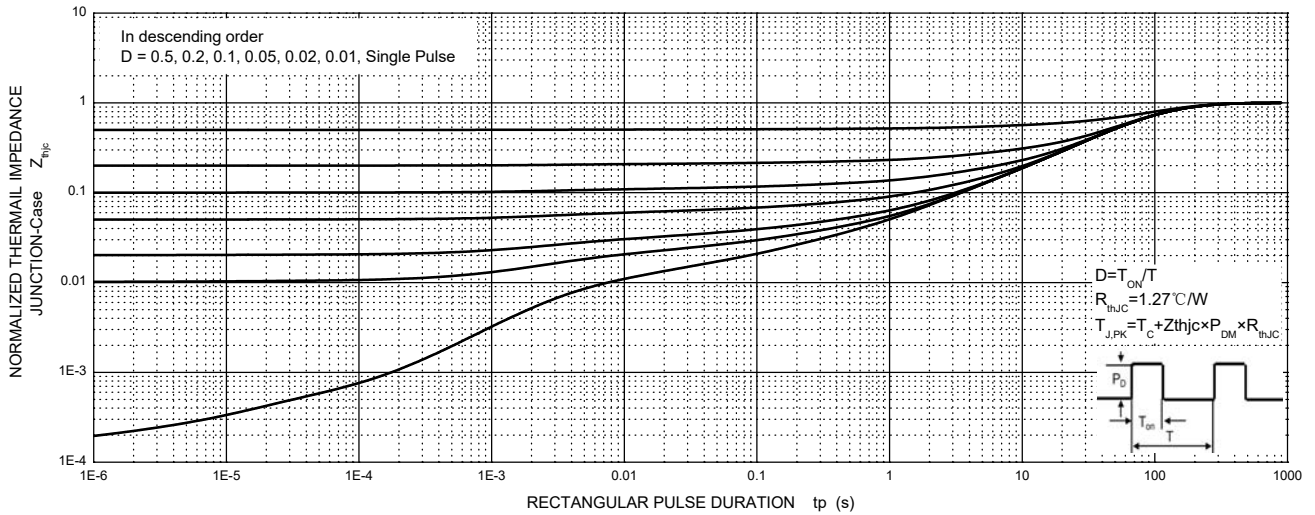


# Typical Characteristics

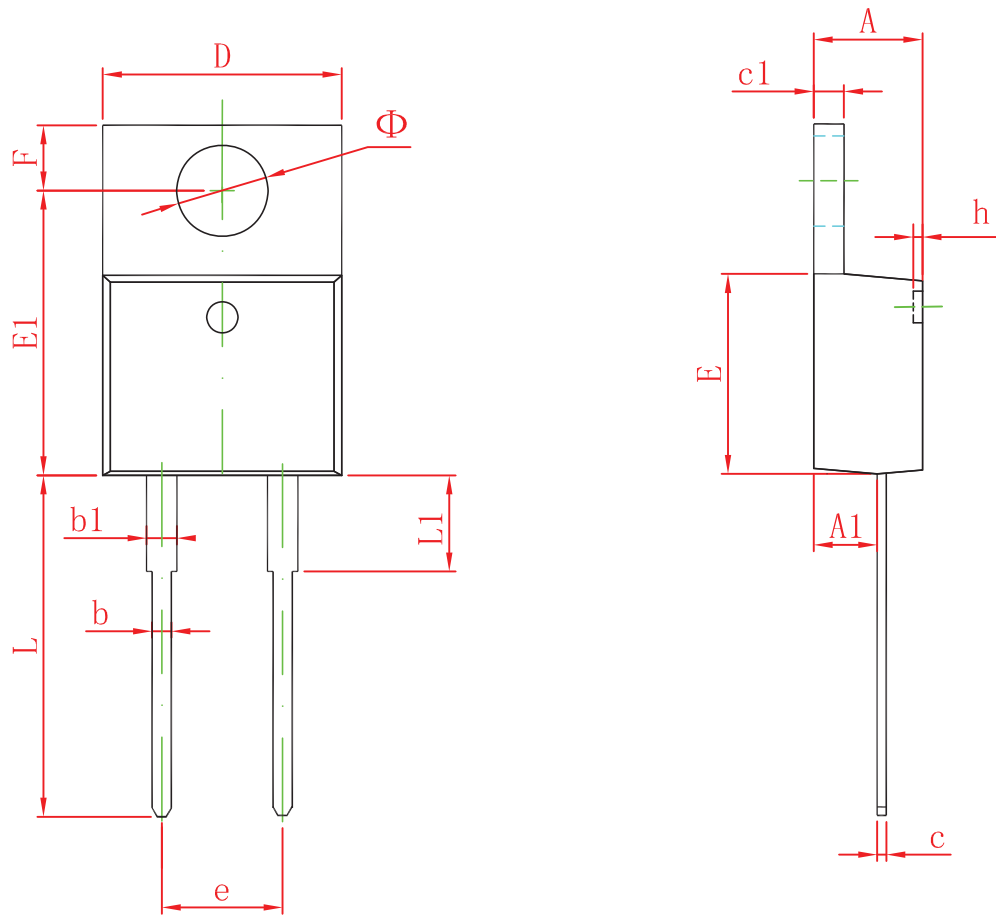
## Current Derating



## CSD20H120 Transient Thermal Impedance, Junction-Case



# TO-220-2L PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	4.450	4.750	0.175	0.187
A1	2.520	2.820	0.099	0.111
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.300	0.500	0.012	0.020
c1	1.170	1.370	0.046	0.054
D	9.830	10.330	0.387	0.407
E	8.500	8.900	0.335	0.350
E1	12.050	12.650	0.474	0.498
e	5.080 TYP		0.200 TYP	
F	2.540	2.940	0.100	0.116
h	0.100 TYP		0.004 TYP	
L	13.300	13.800	0.523	0.543
L1	3.540	3.940	0.139	0.155
Φ	3.735	3.935	0.147	0.155